1. PLATING: ELECTROLESS NICKEL PLATE PER ASTM B 733–90, SC1.
   TYPE-I, CLASS 4, AIMg1Si0.6/NiP 5, 200 ±50 MICRO INCHES THICK.
   MINIMUM PHOSPHORUS CONTENT OF THE NICKEL DEPOSIT SHALL BE 8%.
   OVERPLATE GOLD PER MIL-G-45204 TYPE-III, GRADE A, 25–50 MICRO INCHES THICK.

2. RADIUS ALL EDGES AND CORNERS .04–.06.
   FILLET RADIUS .02 MAX.

3. NOMINAL POSITION OF THE DETECTOR CENTER: FOR REFERENCE ONLY.